A METHOD FOR CHARACTERIZING COPLANAR WAVEGUIDE-TO-MICROSTRIP TRANSITIONS, AND ITS APPLICATION TO THE MEASUREMENT OF MICROSTRIP DEVICES WITH COPLANAR MICROPROBES

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ABSTRACT: This paper presents a method for characterizing coplanar waveguide-to-microstrip (CPW-M) transitions by using on-wafer coplanar (CPW) microprobes. It is based on extracting the transmission matrix of the CPW-M transition from the measurement of the S parameters of two microstrip transmission lines of different lengths, each of which includes two CPW-M transitions. To verify the proposed method, the S parameters of a zero-length line, which is composed of two CPW-M transitions (“thru” connection) and has not been used in the transition characterization, are measured up to 40 GHz and are compared to those extracted and obtained from electromagnetic simulations. The method is applied to the measurement of a microstrip coupled-line filter transitions (“thru” connection) and has not been used in the transition characterization, are measured up to 40 GHz and are compared to those extracted and obtained from electromagnetic simulations. The method is applied to the measurement of a microstrip coupled-line filter embedded in CPW-M transitions. © 2003 Wiley Periodicals, Inc.


Key words: coplanar waveguide-to-microstrip transition; network analyzer calibration; electromagnetic simulation; de-embedding

1. INTRODUCTION

The fast development of MMIC technology and its integration in subsystems at microwave and millimeter-wave frequencies requires the flexibility to use a combination of planar technologies, for example, microstrip and coplanar waveguide (CPW). An example of a joint use of CPW and microstrip transmission media is the need for accurate measurements of microstrip devices at microwave frequencies, which can be accomplished by testing the microstrip device embedded in CPWs, through coplanar (on-wafer) microprobes in a wafer-probe station. To this end, CPW-to-microstrip (CPW-M) transitions have been developed in research laboratories [1–3] and commercially (for example, the Coplanar-Microstrip Test Interface Circuit from JMICRO™ Technology), as illustrated by the configuration for transmission measurements shown in Figure 1, in which a microstrip line is connected to two CPW-M transitions.

On-wafer measurements of CPW devices are performed by using well-known network analyzer calibration techniques [4–8] with appropriate on-wafer CPW reflection (“short,” “open,” and “matched load”) and transmission (a number of CPW lines with different lengths) standards. On-wafer CPW standards are usually well known and good enough to be used up to frequencies exceeding 100 GHz, such as the ISS™ substrate from Cascade-Microtech, which results in a very accurate calibration at millimeter-waves. In a similar way, the measurement of microstrip devices through on-wafer microprobes can also be done by applying one of the former on-wafer calibration procedures to microstrip calibration standards (compatible with the CPW-M transitions), in order to directly refer the measurements to the microstrip plane [see planes 1’–2’ in Fig. 1(a)]. However, microstrip reflection standards are not ideal and/or difficult to be modeled at millimeter-wave frequencies (“short” includes via-holes, and “open” features radiation loss). As an example (see Fig. 2), the measured return loss \(|S_{11}|\) expressed in dB) at 50 GHz of a single JMICRO™ CPW-M open-ended transition (“open” standard), is 1-dB higher than insertion losses of a “thru” standard, composed by a double CPW-M transition (CPW-M-CPW), and 0.5-dB higher than a short-ended transition (“short” standard), due to the losses associated to the reflection standards.

Alternatively, on-wafer standards can be used for calibration at the CPW (on-wafer) planes [0’ and 3’ in Fig. 1(a)], and then the reference plane can be shifted to the microstrip plane [planes 1’–2’ in Fig. 1(a)] by taking into account the CPW-M transition effects. To this end, in [9] a method for measuring transmission parameters of microstrip devices through on-wafer microprobes, which does not use reflection standards, but uses two nonreflecting lines only, is presented. Other authors propose circuit models for the CPW-M transition which are fit to measurements [10], or to electromagnetic simulations [11]. Methods for the measurement of characteristic impedances of CPW and microstrip lines in the millimeter-wave range have also been proposed [12–13]. These methods are based on extracting the ABCD-matrix of CPW-to-CPW transitions [12], or the ABCD matrix of a circuit model associated to differences between two probe-tip-to-CPW line junctions and to CPW-M transitions [13].

In this paper, the method of characterizing CPW-to-CPW transitions in [12] is generalized, applied to the extraction of CPW-M transitions, and compared to electromagnetic simulations. The transmission-matrix (\(T\)-matrix) of the CPW-M transition is extracted from the measurement of the \(S\) parameters of two microstrip transmission lines of different lengths, which include two CPW-M transitions, using on-wafer probes. No restriction in the ratio between the line lengths is made, in contrast with [12], where one line length should be twice that of the other. However, differ-
The trace conservation property, \( \cosh(\text{llB}) \) between matrices \( K \equiv T_{LM}(I_1) \cdot T_{LM}(I_2)^{-1} \), and \( M = T_{LM}(I_1)^{-1} \cdot T_{LM}(I_2) \), with two mathematical properties: (i) trace conservation (\( \text{trace}(K) = \text{trace}(M) \)), and (ii) determinant conservation (\( \det(K) = \det(M) \))[8]. Then, substituting (2) into (3) and using the trace conservation property, \( \cosh(\gamma l_f) \) can be determined from

\[
\cosh(\gamma l_f) = \frac{1}{2} \cdot \text{trace}(T_{LM}(I_2) \cdot T_{LM}(I_2)^{-1}).
\]

where \( Z_0 \) is the reference impedance (usually, \( Z_0 = 50 \Omega \)). In contrast to [9], where the line impedance is \( Z_0 \), an arbitrary impedance \( Z \), is assumed here.

Using the same procedure as in the TRL calibration [4–5], the propagation constant \( \gamma \) can be obtained by combining the measurement of two lines: line \( A \) with length \( I_1 \), and line \( B \) with length \( I_2 \). Then, applying Eq. (1) to each line, the following expression is derived:

\[
T_{ll}(I_1) = \left[ \begin{array}{cc} \cosh(\gamma I_1) - \left( \frac{Z + Z_0}{2Z_0} \right) \cdot \sinh(\gamma I_1) & \left( \frac{Z - Z_0}{2Z_0} \right) \cdot \sinh(\gamma I_1) \\ -\left( \frac{Z - Z_0}{2Z_0} \right) \cdot \sinh(\gamma I_1) & \cosh(\gamma I_1) + \left( \frac{Z + Z_0}{2Z_0} \right) \cdot \sinh(\gamma I_1) \end{array} \right],
\]

where \( I_f \) is the difference between the lengths of line \( A \) and \( B \) (\( I_f = I_2 - I_1 \)). In contrast to [12], where the line-length ratio is restricted, that is, the length of one of the lines must be twice the other one, here no restriction in the ratio between the line lengths is made, with the exception of differences of a half wavelength (and their multiples) between line lengths, which are not allowed.

To compute the line characteristic impedance, we apply the determinant conservation in Eq. (3); by expressing the determinant of \( T_{12}(I_2) \cdot T_{12}(I_2)^{-1} \), and also \( \cosh(\gamma l_f) \) [Eq. (4)], in terms of the \( S \) parameters, \( S_{_{12}}(i = 1, 2 \text{ and } j = 1, 2) \), of a line with length \( I_f \) and the same impedance characteristic \( Z \), the following expression for \( S_{_{12}}(i = 1, 2 \text{ and } j = 1, 2) \) is found [12]:

\[
S_{_{12}} = \frac{b \pm \sqrt{b^2 - 4a}}{2a}
\]

with

\[
a = \det(T_{LM}(I_2) \cdot T_{LM}(I_2)^{-1}), \quad b = 2 \cosh(\gamma l_f),
\]
where the term \( S_{T11} S_{T22} \) has been neglected because the CPW tapered line has been designed to match both the geometrical shape and impedance of the microstrip transmission line and the CPW probe. Knowing \( S_{T21} \), we can derive the microstrip line characteristic impedance \( \mathcal{Z} \) as follows:

\[
\mathcal{Z} = -b_1 \pm \frac{\sqrt{b_1^2 - 4Z_0^2}}{2},
\]

(7)

where

\[
b_1 = \frac{2Z_0 (S_{T12} \cosh (\gamma l) - 1)}{S_{T12} \sinh (\gamma l)}.
\]

(8)

The sign ambiguity in Eqs. (5) and (7) is easily resolved, since a correct determination of both signs will result in a positive value in the real part of \( \mathcal{Z} \).

Next, assuming that the two transitions are identical, but one of them is rotated 180\(^\circ\), the lines with the transitions have a symmetry plane (see Fig. 1); therefore, an even/odd mode analysis can be performed to obtain the \( T \) matrices of the CPW-M transitions, given by

\[
T_1 = \begin{bmatrix} T_{T11} & T_{T12} \\ T_{T21} & T_{T22} \end{bmatrix}; \quad T_2 = \begin{bmatrix} T_{T11} & -T_{T21} \\ -T_{T12} & T_{T22} \end{bmatrix},
\]

(9)

where the determinant of the matrix \( \Delta = \begin{vmatrix} T_{T11} & T_{T22} \\ T_{T22} & T_{T11} \end{vmatrix} \), \( T_{T22} = 1 \), since the transitions are reciprocal. For each line measured (with a length \( l \)), we can split the measured \( S \) parameters as [see Fig. 1(b) and 1(c)]:

\[
S(l) = \frac{1}{2} \left[ \Gamma(l) + \Gamma(l) - \Gamma(l) + \Gamma(l) \right],
\]

(10)

where, in Eq. (10) only, the input reflection coefficient for each case (even and odd mode) can be expressed as:

\[
\Gamma_e(l) = \frac{Z_{in}(l) - Z_0}{Z_{in}(l) + Z_0} = S_{11}(l) + S_{12}(l),
\]

(11)

\[
\Gamma_o(l) = \frac{Z_{in}(l) - Z_0}{Z_{in}(l) + Z_0} = S_{11}(l) - S_{12}(l).
\]

(12)

The input impedance for each mode is expanded as

\[
\frac{Z_{in}(l)}{Z_0} = \frac{T_{11} (Z_{l1} + Z_0) + T_{22} (Z_{l2} - Z_0)}{Z_{l1} + Z_0 + T_{22} (Z_{l2} - Z_0)},
\]

(13)

\[
\frac{Z_{in}(l)}{Z_0} = \frac{T_{11} (Z_{l1} + Z_0) + T_{22} (Z_{l2} - Z_0)}{Z_{l1} + Z_0 + T_{22} (Z_{l2} - Z_0)},
\]

(14)

where \( T_1, T_2, T_3, \) and \( T_4 \) are defined as a function of the transition \( T \) parameters:

\[
T_3 = T_{T22} - T_{T12},
\]

\[
T_4 = T_{T21} - T_{T11},
\]

(15)

and \( Z_{l1} = Z \cdot \coth(\gamma l/2) \) and \( Z_{l2} = Z \cdot \tanh(\gamma l/2) \) are the input impedance of an open and shorted transmission line of length \( l/2 \), respectively, \( Z \) is the impedance computed from Eq. (7), and \( \gamma \) is computed from Eq. (4). Using Eqs. (13) and (14) for each line (\( A \) and \( B \)), the following equation system can be found:

\[
\left( Z_{lA} + Z_0 \right) \cdot \frac{T_{11}}{T_{11}} + \left( Z_{lA} - Z_0 \right) \cdot \frac{T_{33}}{T_{33}} = \frac{Z_{in}(l)}{Z_0} = \left( Z_{lA} + Z_0 \right),
\]

(16)

where \( Z_{lA}, \) \( Z_{lB}, \) and \( Z_{lB} \) are defined as a function of known parameters: \( l_A, l_B, \) and \( \gamma, \) and \( Z_{lA}, Z_{lB} \) are known from the measured \( S \) parameters of the lines \( A \) and \( B \) through Eqs. (11) and (12). Solving the system of Eq. (16) for \( (T_1/T_{11}), (T_2/T_{12}), (T_3/T_{33}), \) and using the reciprocity property of the transition (\( \Delta = T_{T11} \cdot T_{T22} - T_{T12} \cdot T_{T21} = 1 \)), \( T_3 \) can be obtained from

\[
\frac{1}{2} \left[ \frac{T_{11}}{T_{12}} - \frac{T_3}{T_{12}} \right] = \frac{1}{2} \left[ \frac{T_{11}}{T_{12}} \right].
\]

(17)

Once \( T_3 \) is calculated, \( T_1, T_2, \) and \( T_4 \) are computed from \( (T_1/T_{11}), (T_2/T_{12}), (T_3/T_{33}), (T_1/T_{11}), (T_2/T_{12}), \) and \( T_{T22} \) are computed from Eq. (15), and the adapter \( T \) matrix is determined.

### 3. Simulation of the Transition Using an Electromagnetic Simulator

In order to compare the proposed method to characterize the CPW-M transition, described in section 2, with the electromagnetic simulations (as suggested by other authors [11]), the 2.5D electromagnetic simulator Momentum (from Agilent) is used here. The simulation details are shown in Figure 3: the layout of a single CPW-M transition [Fig. 3(a)], and the transition layout dimensions [Fig. 3(b)]. The parameters of the alumina substrate used in the Momentum simulation are as follows: permittivity \( \varepsilon_r = 9.9 \), metal thickness \( t = 3 \mu m \), dielectric thickness \( h = 10 \text{ mil} \), conductivity \( \sigma = 4 \cdot 10^7 \text{ S/m} \), loss tangent \( \tan \delta = 0.04 \).

Prior to the transition simulation, Momentum is used to compute the \( S \) parameters of a zero-length line, which is composed of two CPW-M transitions (see Fig. 1(a), “thru” connection, \( I = 0 \)
and they are compared to the measured $S$ parameters. This calculation is developed to determine the loss tangent $\tan \delta$, since it is unknown, and the losses (return 0 insertion loss) are mainly due to this parameter. Once the loss tangent is known, the transition is simulated with Momentum using the half layout of a zero-length line [Fig. 3(a)]. The structure is defined as microstrip, therefore, via holes can be easily included. To consider the coplanar probe configuration, ground-signal-ground (G-S-G), three Momentum ports, at the probe position, are defined. The signal port [port 1 in Fig. 3(a)] is defined as an “internal port,” the CPW ground ports [ports 3 and 4 in Fig. 3(a)] are defined as “ground” and associated with the internal port 1. In this way, port 1 (CPW signal) is referred to the ground ports (CPW ground). The results obtained using the Momentum simulator are included into the dataset of a schematic circuit, the ground ports are connected externally to ground, and the internal port is connected to the reference load. In order to simulate the transition as a two-port one, a fourth port is connected to the microstrip-end as a single port [port 2 in Fig. 3(a)]. The results of the electromagnetic simulation and comparison with the experimental results are given in next section.

4. EXPERIMENTAL RESULTS

The method proposed in section 2 has been used to characterize a CPW-M transition from JMICRO™ Technology. The $S$ parameters of two lines ($A$ and $B$), each of which includes two CPW-M transitions, were measured. The length of line $A$ is $l_A = 663$ μm (corresponding to an electrical delay of 5 ps), and the length of line $B$ is $l_B = 1887$ μm (electrical delay of 15 ps). The measurement of the line $S$ parameters was made using an HP 8510C Automatic Network Analyzer connected to an on-wafer Probe Station (SUMMIT-9000) from Cascade-Microtech, equipped with ACP40-GSG-150 cascade microprobes. On-wafer calibration was performed by applying the line-reflect-reflect-match (LRRM) method [8] to CPW (on-wafer) standards (Cascade-Microtech 101-190 LRM impedance standard substrate).

Figure 4 shows the line characteristic impedance obtained from Eq. (7). Its real part is very close to 50 Ω, and its imaginary part is negligible, except for the lower frequency range, where the real part increases and the imaginary part increases (negatively). This behavior is well known from transmission-line theory. Therefore, for transition characterization purposes, we can assume $Z \approx 50$ Ω.
probes and calibration mentioned above. Then, the filter parameters are measured at the coplanar plane with the same on-wafer measurement of microstrip devices, Figure 7 shows a coupled-line filter wire-bonded to CPW-M transition. This technique can be generalized to other types of transitions such as coaxial-to-microstrip.

5. CONCLUSION

In this paper a procedure for characterizing coplanar-to-microstrip (CPW-M) transitions has been presented. The transmission matrix (T matrix) of the CPW-M transition was extracted from the measured S parameters of two microstrip lines, each of which include two CPW-M transitions. The results of the transition T-matrix extraction were compared to those obtained with electromagnetic simulations (using the Momentum simulator) and very good agreement was shown. To verify the results, the S parameters of a thru line (zero-length line) were calculated using the extracted transition T matrix and compared to those simulated with Momentum. The magnitude of the de-embedded S11 is lower than those directly measured at the CPW plane because the CPW-M transition and the coupled line filter are well-matched. However, the magnitude of the de-embedded S12 is lower than those directly measured at the CPW plane because the CPW-M insertion loss contribution has been discounted. In the same way, a shift in the phases of S11 and S12 can be seen between the measurements at CPW and microstrip plane. The de-embedded S parameters show good agreement with those obtained from the Momentum simulation.

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Figure 6  S parameters of a coupled line filter: measured at the coplanar plane (-), de-embedded at the microstrip plane (-o-), and simulated with Momentum, including the bonding wires (- -). [Color figure can be viewed in the online issue, which is available at www.interscience.wiley.com.]

Figure 8  S parameters of a coupled line filter: measured at the coplanar plane (-), de-embedded at the microstrip plane (-o-), and simulated with Momentum, including the bonding wires (- -). [Color figure can be viewed in the online issue, which is available at www.interscience.wiley.com.]

Figure 7  Coupled line filter wire-bonded to CPW-M transition. [Color figure can be viewed in the online issue, which is available at www.interscience.wiley.com.]
AN ITERATIVE METHOD FOR SOLVING A LARGE DENSE MATRIX IN THE METHOD OF MOMENTS SOLUTION OF AN ELECTROSTATIC PROBLEM

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ABSTRACT: This paper illustrates the application of Wynn’s vector ε-algorithm to solve a system of equations arising in the method of moments (MoM) solution of an electrostatic problem. Since the method is iterative, it does not require inversion of a matrix. The degree of accuracy of the solution can be controlled by specifying a convergence factor. © 2003 Wiley Periodicals, Inc. Microwave Opt Technol Lett 39: 378–380, 2003; Published online in Wiley InterScience (www.interscience.wiley.com). DOI 10.1002/mop.11223

Key words: integral equations; method of moments; iterative method; solution of dense matrix; Wynn’s vector algorithm

1. INTRODUCTION

Obtaining the numerical solution of electromagnetic radiation or scattering problems by using the method of moments (MoM) leads to a system of linear equations, which can be solved by matrix inversion, Gaussian elimination, or iterative techniques. However, an inherent limitation of the MoM is that it results in the generation of a dense matrix, which makes the solution process very time consuming, specifically, for electrically large structures. To overcome this limitation and to extend the application of MoM to the high-frequency regime, several alternative techniques have been suggested. The methods suggested so far include the multilevel fast-multiple algorithm [1], the impedance-matrix localization [2], the application of specially constructed adaptive-basis functions [3], and iterative methods such as the conjugate-gradient method [4] and the method of steepest descent [5].

In this work, we present an iterative technique for solving the MoM matrix problem. The method is based on the vector ε-algorithm proposed by Wynn [6]. The application of the method is illustrated by applying it to find the charge distribution on a conducting strip using the MoM. Since this method is iterative, matrix inversion is not needed. The solution process can be stopped when a predefined convergence criterion is met. This is advantageous, as higher accuracy in the solution can be obtained by making the convergence criterion more stringent. The storage requirements needed in the solution process are considerably modest. Typically, to solve an $N \times N$ matrix problem, the method requires a working space equivalent to two $N \times p$ matrices where $p \ll N$. The numerical results presented here illustrate the usefulness of the method. The advantage of Wynn’s vector ε-algorithm over the biconjugate gradient method has been pointed out by Brezinski [7]. The biconjugate-gradient method’s limitation is that it may have a breakdown, which would cause the algorithm to stop, or a near breakdown, which would cause the propagation of round-off errors, resulting in a failure of convergence. In Wynn’s algorithm, such a breakdown or near breakdowns are curable. Brezinski has shown that under certain conditions, Wynn’s algorithm can be used to solve a system of linear equations, $AX = b$, where $A$ is a real, singular, square matrix [6].

2. WYNN’S VECTOR ε-ALGORITHM

Let us solve, say, the following matrix problem given by the system of linear equations:

$$AX = b,$$  \hspace{1cm} (1)

where $A$ is a known $N \times N$ MoM matrix $A = [a_{ij}]$, $X$ is an unknown $N \times 1$ column vector, $X = (x_1, x_2, \ldots, x_N)^T$, and $b$ is a known $N \times 1$ forcing function vector $b = (b_1, b_2, \ldots, b_N)^T$. Wynn’s algorithm provides an estimate of $X$ without the use of matrix inversion.

In the ε-algorithm, the starting vectors $\{e^{(0)}\}$ and $\{e^{(0)}\}'$, each of length $N$, are constructed from the initial values:

$$\{e^{(q)}\} = \{0\}, \hspace{1cm} q = 1, 2, \ldots$$  \hspace{1cm} (2)

$$\{e^{(q)}\}' = \{S^{(0)}\} = \{0\},$$

$$\{e^{(q)}\}' = \{S^{(0)}\}, \hspace{1cm} q = 1, 2, \ldots$$  \hspace{1cm} (3)

The initial vectors, $S^{(q)} = (s_1^{(q)}, s_2^{(q)}, \ldots, s_N^{(q)})$, can be calculated using the Gauss–Seidel relaxation [8]:

$$s_i^{(q)} = \frac{1}{a_{ii}} \left( b_i - \sum_{j \neq i} a_{ij} s_j^{(q-1)} \right), \hspace{1cm} i = 1, 2, \ldots, N$$  \hspace{1cm} (4)

The iterative process is then continued with the following update equations:

$$\{e^{(q+1)}\} = \{e^{(q)}\} - \{S^{(q)}\},$$

$$\{e^{(q+1)}\}' = \{e^{(q)}\}' - \{S^{(q)}\}'$$  \hspace{1cm} (5)

where $S^{(q)} = (s_1^{(q)}, s_2^{(q)}, \ldots, s_N^{(q)})$ and $S^{(q)} = (s_1^{(q)}, s_2^{(q)}, \ldots, s_N^{(q)})$.

The iterative process is then continued until a convergence criterion is met. The convergence criterion is typically a tolerance on the difference between consecutive iterates. The process is then stopped when the criterion is met.